

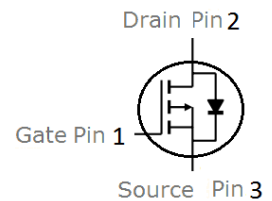
Features

- P-Channel, 5V Logic Level Control
- Enhancement mode
- Very low on-resistance $R_{DS(on)}$ @ $V_{GS}=-4.5$ V
- Fast Switching
- 100% Avalanche Tested
- Pb-free lead plating; RoHS compliant; Hg-Free

V_{DS}	-100	V
$R_{DS(on),TYP} @ V_{GS}=-10$ V	45	m Ω
$R_{DS(on),TYP} @ V_{GS}=-4.5$ V	48	m Ω
I_D	-25	A



Part ID	Package Type	Marking	Tape and reel information
VSI050P10MS	TO-251	050P10M	75cs/Tube



Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit	
Common Ratings ($T_c = 25^\circ\text{C}$ Unless Otherwise Noted)				
V_{GS}	Gate-Source Voltage	± 20	V	
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	-100	V	
T_J	Maximum Junction Temperature	175	$^\circ\text{C}$	
T_{STG}	Storage Temperature Range	-55 to 175	$^\circ\text{C}$	
I_S	Diode Continuous Forward Current	$T_c = 25^\circ\text{C}$	-25	A
Mounted on Large Heat Sink				
I_{DM}	Pulse Drain Current Tested ①	$T_c = 25^\circ\text{C}$	-100	A
I_D	Continuous Drain current @ $V_{GS}=10$ V	$T_c = 25^\circ\text{C}$	-25	A
P_D	Maximum Power Dissipation	$T_c = 25^\circ\text{C}$	88	W
$R_{\theta JC}$	Thermal Resistance-Junction to Case		1.7	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance Junction-Ambient($t_s < 10$ s)		50	$^\circ\text{C/W}$
Drain-Source Avalanche Ratings				
EAS	Avalanche Energy, Single Pulsed ②		81	mJ

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ T_j = 25°C (unless otherwise stated)						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =-250μA	-100	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current(T _j =25°C)	V _{DS} =-100V,V _{GS} =0V	--	--	-1	μA
	Zero Gate Voltage Drain Current(T _j =125°C)	V _{DS} =-100V,V _{GS} =0V	--	--	-10	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V,V _{DS} =0V	--	--	±100	nA
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} =V _{GS} ,I _D =-250μA	-1.0	-2.0	-3.0	V
R _{DS(ON)}	Drain-Source On-State Resistance ^③	V _{GS} =-10V, I _D =-20A	--	45	50	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance ^③	V _{GS} =-5V, I _D =-10A	--	48	55	mΩ
Dynamic Electrical Characteristics @ T_j = 25°C (unless otherwise stated)						
C _{iss}	Input Capacitance	V _{DS} =-50V,V _{GS} =0V, f=1MHz	--	5430	--	pF
C _{oss}	Output Capacitance		--	245	--	pF
C _{rss}	Reverse Transfer Capacitance		--	175	--	pF
Q _g	Total Gate Charge	V _{DS} =-50V,I _D =-10A, V _{GS} =-10V	--	55	--	nC
Q _{gs}	Gate-Source Charge		--	10	--	nC
Q _{gd}	Gate-Drain Charge		--	14	--	nC
Switching Characteristics						
t _{d(on)}	Turn-on Delay Time	V _{DD} =-50V, I _D =-1A, R _G =6.8Ω, V _{GS} =-10V	--	18	--	nS
t _r	Turn-on Rise Time		--	22	--	nS
t _{d(off)}	Turn-Off Delay Time		--	52	--	nS
t _f	Turn-Off Fall Time		--	60	--	nS
Source- Drain Diode Characteristics @ T_j = 25°C (unless otherwise stated)						
I _{SD}	Source-drain current(Body Diode)	T _c =25°C	--	--	-25	A
V _{SD}	Forward on voltage	I _{SD} =-20A,V _{GS} =0V	--	0.86	-1.3	V
t _{rr}	Reverse Recovery Time	T _j =25°C,I _{sd} =-15A, V _{GS} =0V	--	45	--	nS
Q _{rr}	Reverse Recovery Charge	di/dt=-100A/μs		115		nC

NOTE:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Limited by T_{Jmax}, starting T_J = 25°C, L = 0.5mH,R_G = 25Ω, I_{AS} = -18A, V_{GS} = -10V. Part not recommended for use above this value
- ③ Pulse width ≤ 300μs; duty cycle ≤ 2%.

Typical Characteristics

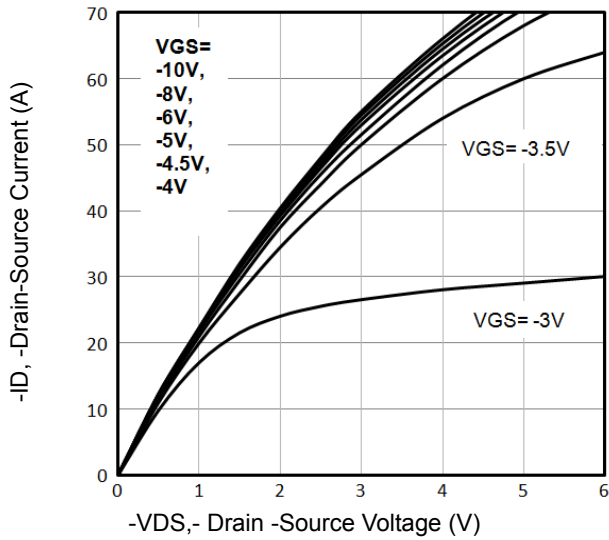


Fig1. Typical Output Characteristics

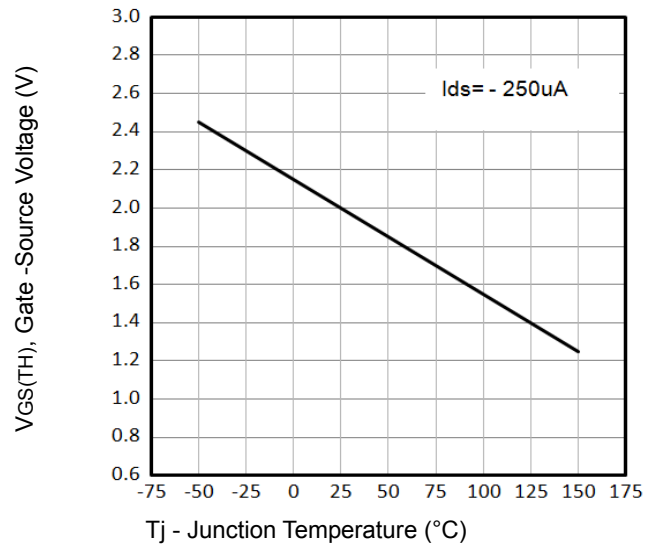


Fig2. $V_{GS(TH)}$ Gate -Source Voltage Vs. T_j

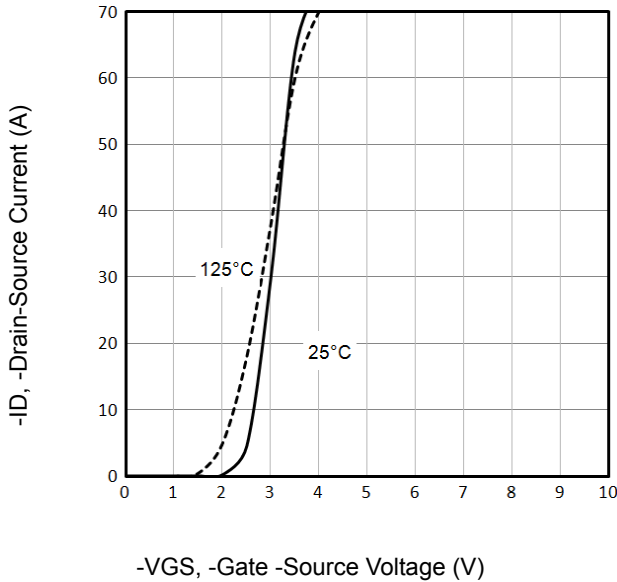


Fig3. Typical Transfer Characteristics

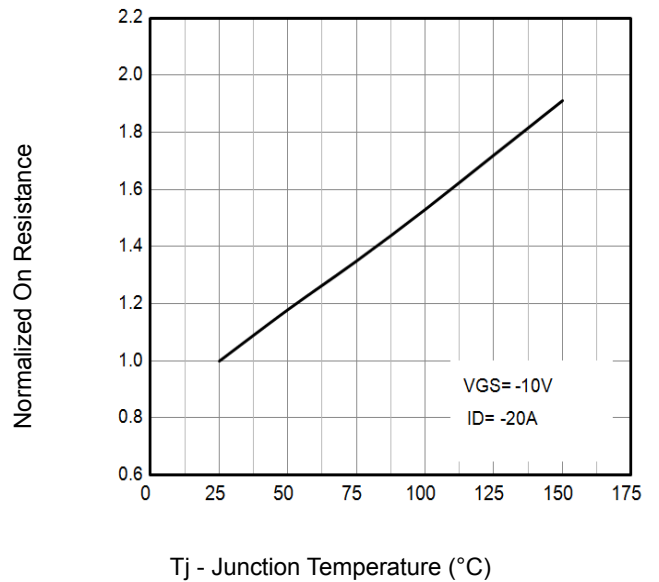


Fig4. Normalized On-Resistance Vs. T_j

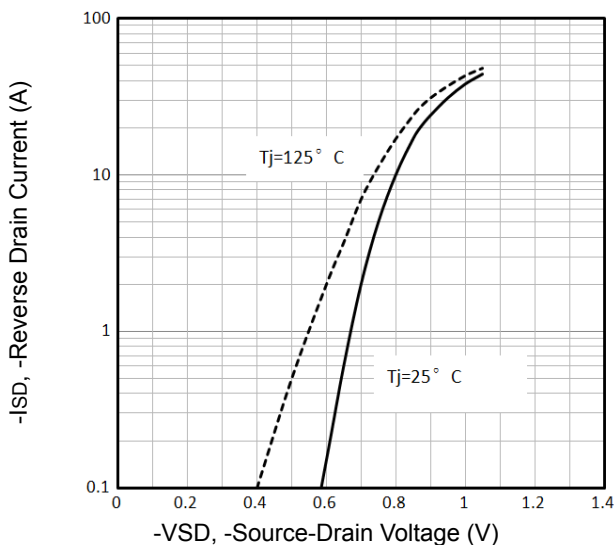


Fig5. Typical Source-Drain Diode Forward Voltage

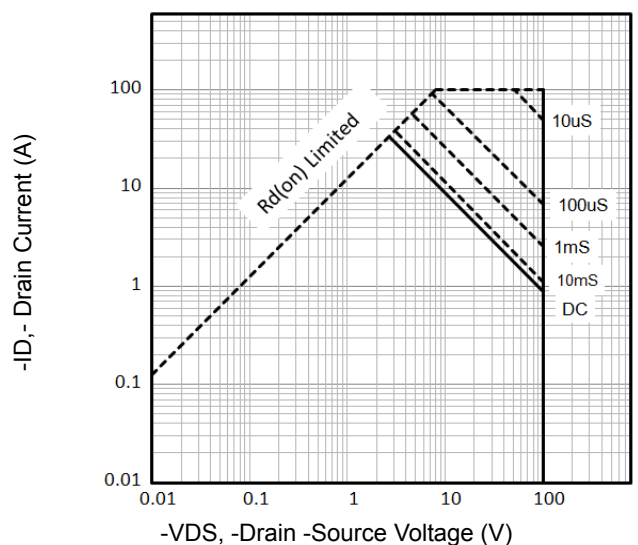


Fig6. Maximum Safe Operating Area

Typical Characteristics

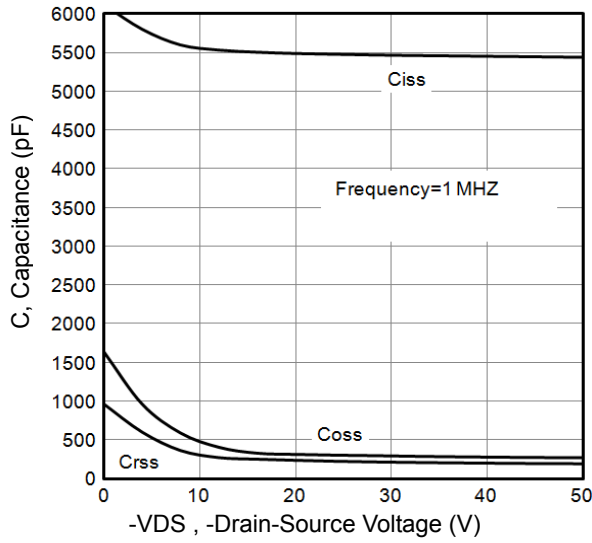


Fig7. Typical Capacitance Vs.Drain-Source Voltage

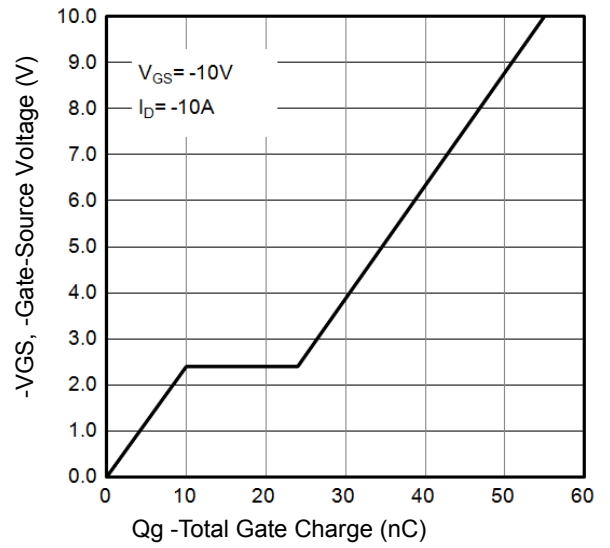


Fig8. Typical Gate Charge Vs.Gate-Source Voltage

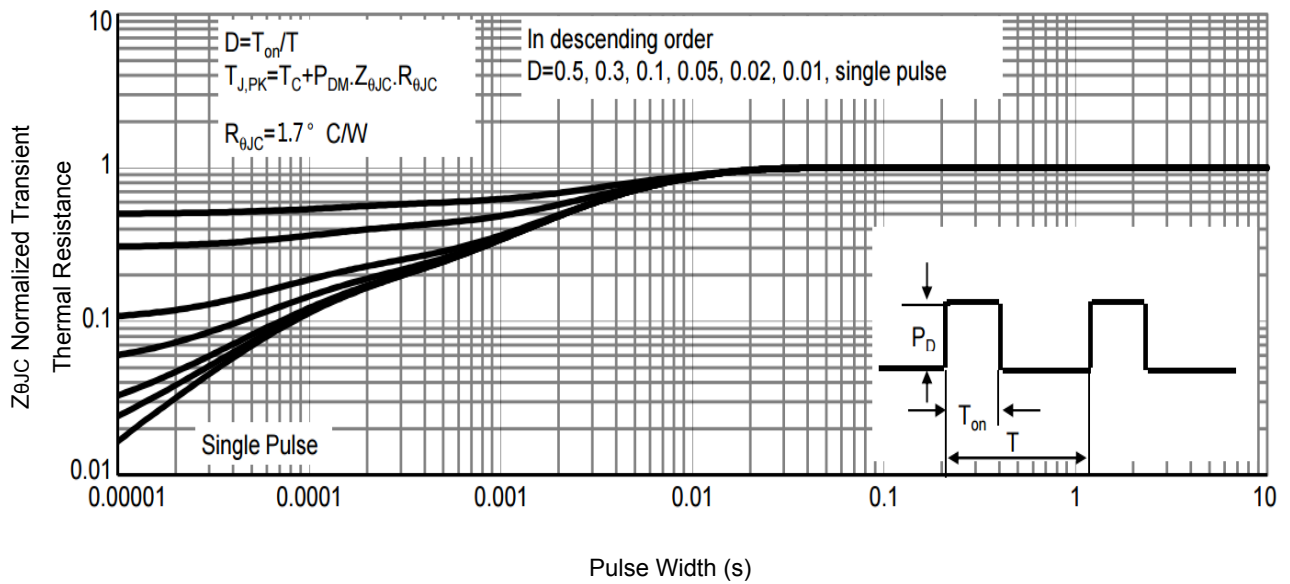


Fig9. Normalized Maximum Transient Thermal Impedance

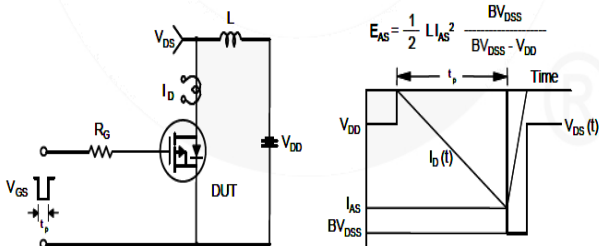


Fig10. Unclamped Inductive Test Circuit and Waveforms

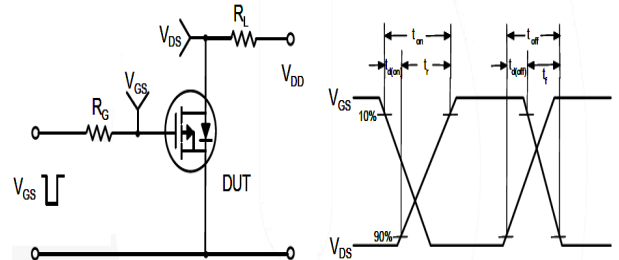
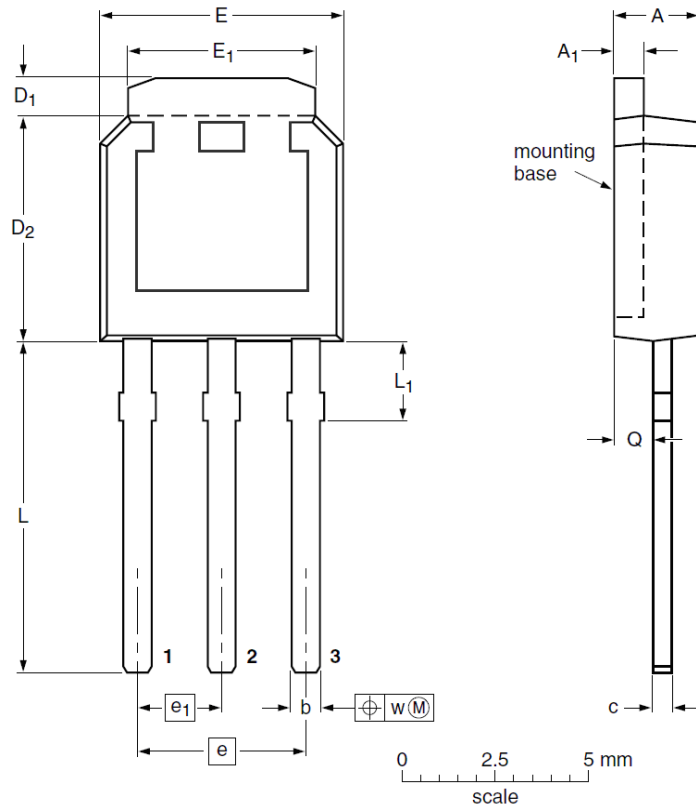


Fig11. Switching Time Test Circuit and waveforms

TO-251 Package Outline Data



DIMENSIONS (unit : mm)

Label	Min	Typ	Max	Label	Min	Typ	Max
A	2.22	2.30	2.38	A ₁	0.46	0.55	0.93
b	0.71	0.78	0.89	c	0.46	0.51	0.56
D ₁	0.96	1.02	1.10	D ₂	5.98	6.05	6.22
E	6.47	6.60	6.73	E ₁	5.20	5.33	5.55
e	--	4.57	--	e ₁	--	2.28	--
L	9.20	9.38	9.60	L ₁	--	2.70	--
Q	1.00	1.05	1.10	w	--	0.30	--

Customer Service

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